2SK1637, 2SK2422

Silicon N-Channel MOS FET

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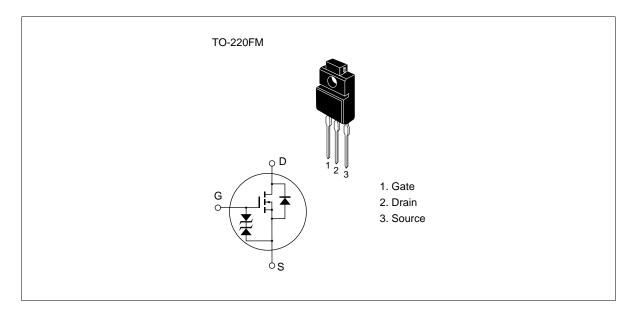
Application

High speed power switching

Features

- Low on-resistance
- High speed switching
- Low drive current
- No secondary breakdown
- Suitable for switching regulator and DC-DC converter

Outline





<u>2SK1637, 2SK2422</u>

Absolute Maximum Ratings (Ta = 25°C)

Item		Symbol	Ratings	Unit
Drain to source voltage	2SK1637	V _{DSS}	600	V
	2SK2422		650	
Gate to source voltage		V _{GSS}	±30	V
Drain current		I _D	4	А
Drain peak current		L *1 D(pulse)	16	А
Body to drain diode reverse drain current		I _{DR}	4	А
Channel dissipation		Pch*2	35	W
Channel temperature		Tch	150	°C
Storage temperature		Tstg	-55 to +150	°C

Note 1. $PW \le 10 \ \mu s$, duty cycle $\le 1\%$

2. Value at T_c = $25^{\circ}C$

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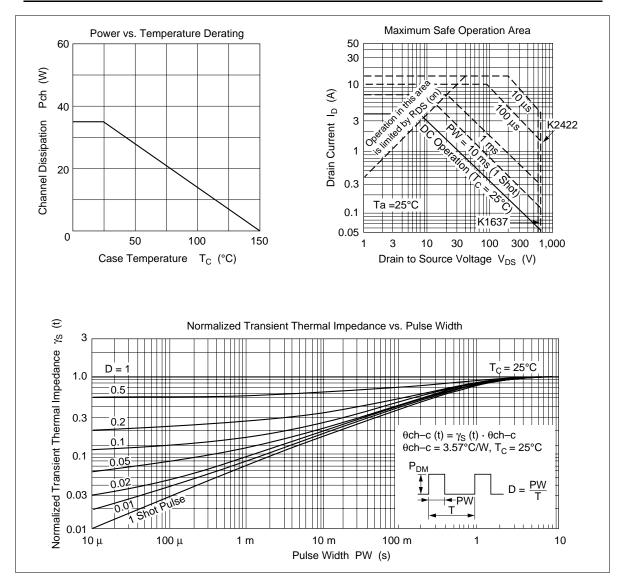
Item		Symbol	Min	Тур	Max	Unit	Test conditions
Drain to source	2SK1637	$V_{(\text{BR})\text{DSS}}$	600	—	_	V	$I_{\rm D} = 10 \text{ mA}, V_{\rm GS} = 0$
breakdown voltage	2SK2422	-	650	_			
Gate to source breakdown voltage		$V_{(BR)GSS}$	±30	_	_	V	$I_{G} = \pm 100 \ \mu A, \ V_{DS} = 0$
Gate to source leak current		I _{GSS}	—	—	±10	μA	$V_{\text{GS}} = \pm 25 \text{ V}, V_{\text{DS}} = 0$
Zero gate voltage	2SK1637	I _{DSS}	—	—	250	μA	$V_{\rm DS} = 500 \text{ V}, V_{\rm GS} = 0$
drain current	2SK2422	-					$V_{\rm DS} = 550 \text{ V}, \text{ V}_{\rm GS} = 0$
Gate to source cutoff	voltage	$V_{GS(off)}$	2.0	_	3.0	V	$I_{\rm D} = 1 \text{ mA}, V_{\rm DS} = 10 \text{ V}$
Static Drain to source	2SK1637	$R_{\text{DS(on)}}$	—	1.8	2.4	Ω	$I_{\rm D} = 2$ A, $V_{\rm GS} = 10$ V * ¹
on state resistance	2SK2422	-	—	2.0	2.6	-	
Forward transfer admi	ittance	yfs	2.2	3.5	_	S	$I_{\rm D} = 2$ A, $V_{\rm DS} = 10$ V * ¹
Input capacitance		Ciss	—	600	_	pF	$V_{DS} = 10 \text{ V}, \text{ V}_{GS} = 0,$
Output capacitance		Coss	—	140	—	pF	f = 1 MHz
Reverse transfer capacitance		Crss	—	25	—	pF	
Turn-on delay time		t _{d(on)}	—	8	_	ns	$I_{\rm D} = 2$ A, $V_{\rm GS} = 10$ V,
Rise time		t,	—	30	_	ns	$R_{L} = 15 \Omega$
Turn-off delay time		t _{d(off)}	_	60	_	ns	
Fall time		t _f		35	_	ns	-
Body to drain diode fo voltage	rward	V_{DF}	_	0.9	_	V	$I_{F} = 4 \text{ A}, V_{GS} = 0$
Body to drain diode reverse recovery time		t _{rr}	—	300	_	ns	$I_F = 4 \text{ A}, V_{GS} = 0,$ $di_F/dt = 100 \text{ A}/\mu\text{s}$

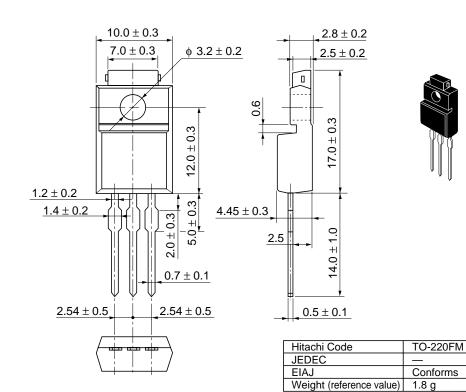
Electrical Characteristics (Ta = 25°C)

Note 1. Pulse test

See characteristics curves of 2SK1402, 2SK1402A.

2SK1637, 2SK2422





Unit: mm

Cautions

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